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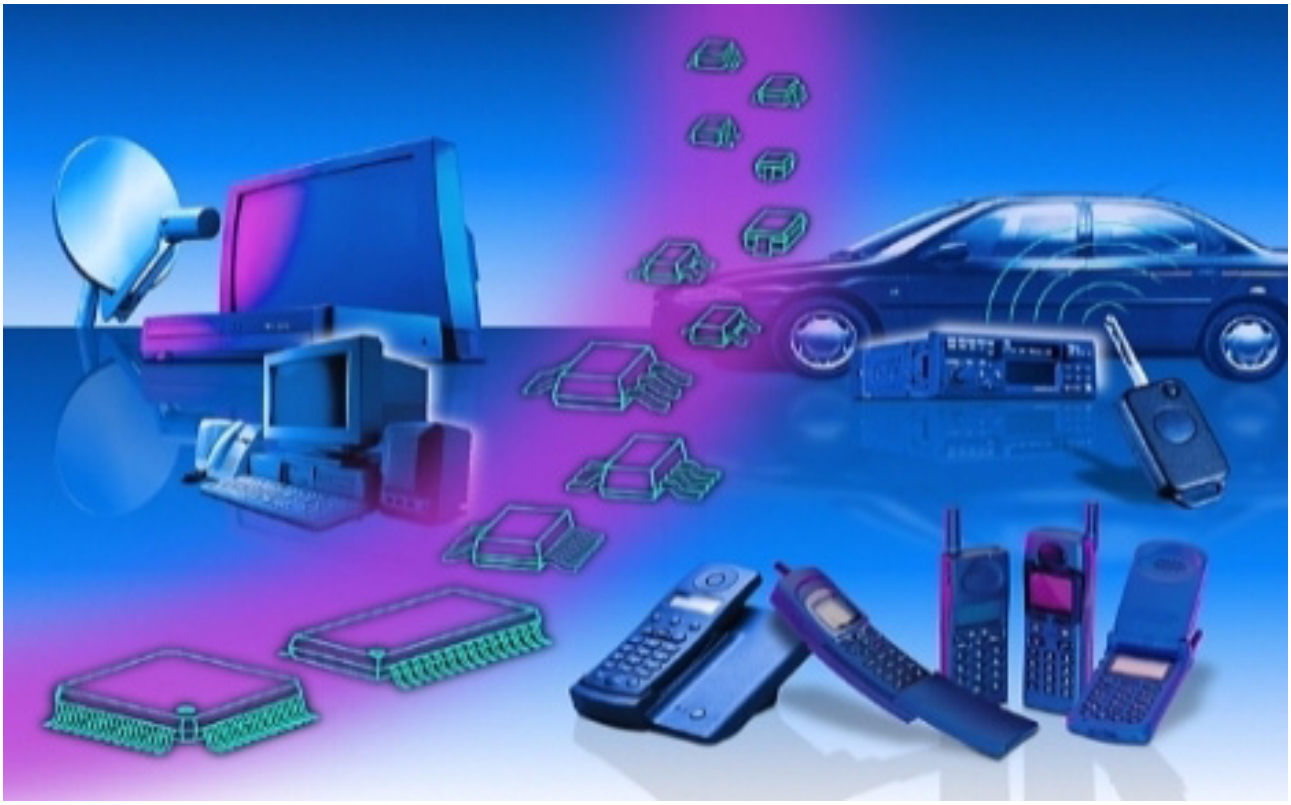

Wireless Components

ASK/FSK Transmitter 868/433 MHz

TDK 5100 Version 1.1

Specification May 2012

Preliminary **Revision History**		
Current Version: Version 1.1 as of 09.05.2012		
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Product Info	Product Info	Package Info corrected to PG-TSSOP-16 Ordering Code corrected to SP000014557

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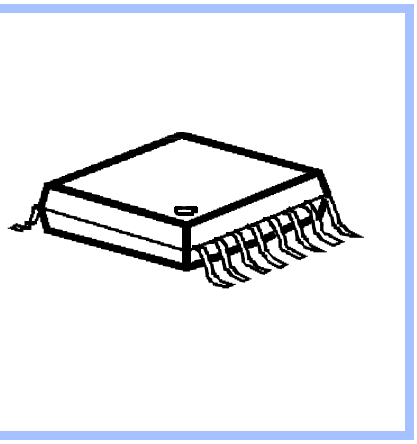
Product Info

General Description

The TDK 5100 is a single chip ASK/FSK transmitter for the frequency bands 433-435 and 868-870 MHz. The IC offers a high level of integration and needs only a few external components. The device contains a fully integrated PLL synthesizer and a high efficiency power amplifier to drive a loop antenna. A special circuit design and an unique power amplifier design are used to save current consumption and therefore to save battery life. Additionally features like a power down mode, a low power detect, a selectable crystal oscillator frequency and a divided clock output are implemented. The IC can be used for both ASK and FSK modulation.

Package



Features

- fully integrated frequency synthesizer
- VCO without external components
- ASK and FSK modulation
- switchable frequency range 433-435 MHz / 868-870 MHz
- high efficiency power amplifier (typically 5 dBm / 2 dBm)
- low supply current (typically 7mA)
- voltage supply range 2.1 - 4 V
- temperature range -40 ... +125°C
- power down mode
- low voltage sensor
- selectable crystal oscillator 6.78 MHz / 13.56 MHz
- programmable divided clock output for µC
- low external component count

Applications

- Keyless entry systems
- Remote control systems
- Alarm systems
- Communication systems

Ordering Information

Type	Ordering Code	Package
TDK 5100	SP000014557	PG-TSSOP-16
available on tape and reel		

1 Product Description

Contents of this Chapter

1.1 Overview

The TDK 5100 is a single chip ASK/FSK transmitter for the frequency bands 433-435 MHz and 868-870 MHz. The IC offers a high level of integration and needs only a few external components. The device contains a fully integrated PLL synthesizer and a high efficiency power amplifier to drive a loop antenna. A special circuit design and an unique power amplifier design are used to save current consumption and therefore to save battery life. Additional features like a power down mode, a low power detect, a selectable crystal oscillator frequency and a divided clock output are implemented. The IC can be used for both ASK and FSK modulation.

1.2 Applications

- Keyless entry systems
- Remote control systems
- Alarm systems
- Communication systems

1.3 Features

- fully integrated frequency synthesizer
- VCO without external components
- ASK and FSK modulation
- switchable frequency range 433-435 MHz / 868-870 MHz
- high efficiency power amplifier (typically 5 dBm / 2 dBm)
- low supply current (typically 7 mA)
- voltage supply range 2.1 - 4 V
- temperature range -40°C ... 125°C
- power down mode
- low voltage sensor
- selectable crystal oscillator 6.78 MHz / 13.56 MHz
- programmable divided clock output for µC
- low external component count

1.4 Package Outlines

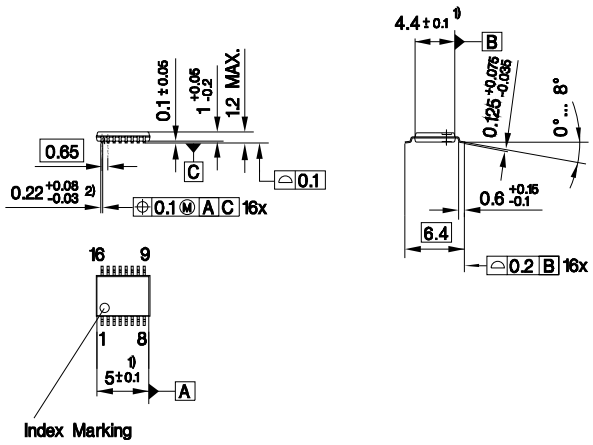
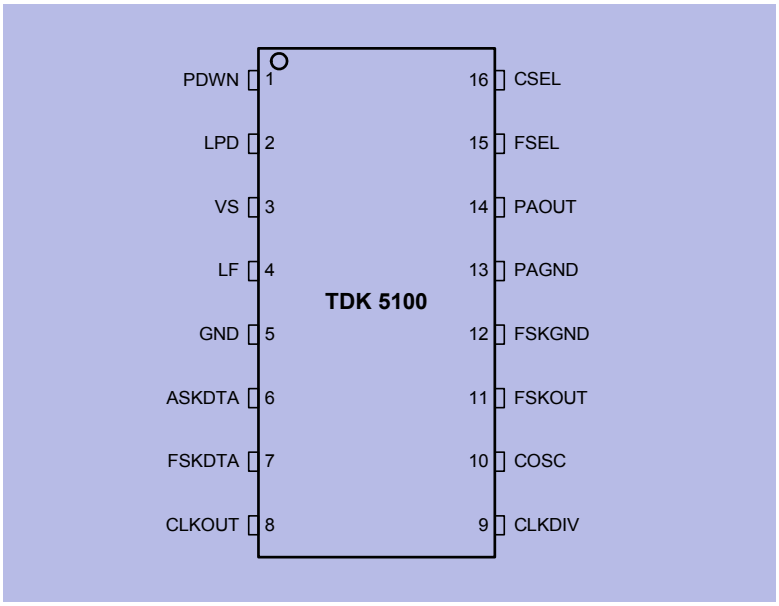


Figure 1-1 PG-TSSOP-16

2 Functional Description

Contents of this Chapter

2.1 Pin Configuration



Pin_config.wmf

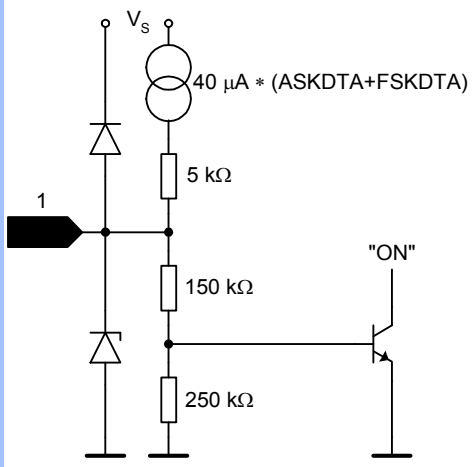
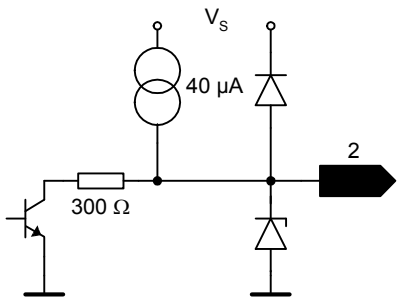
Figure 2-1 IC Pin Configuration

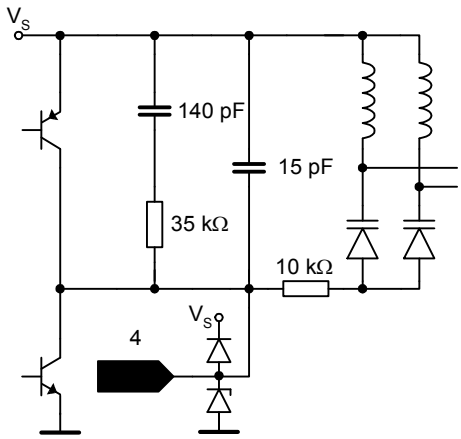
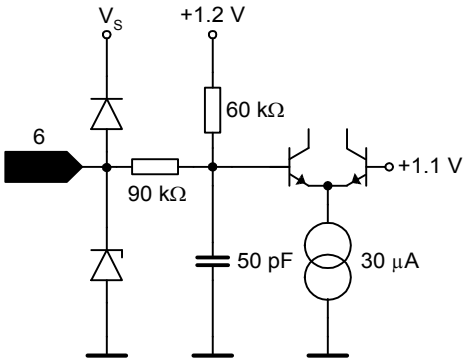
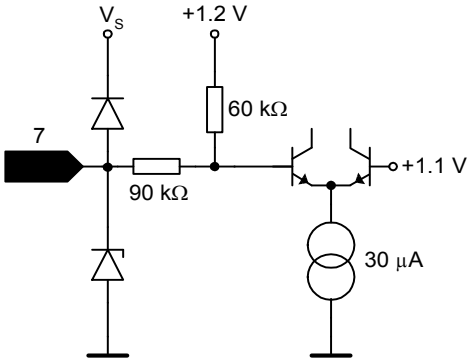
Table 2-1

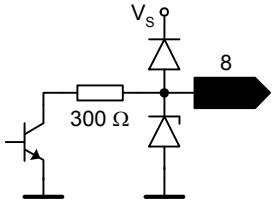
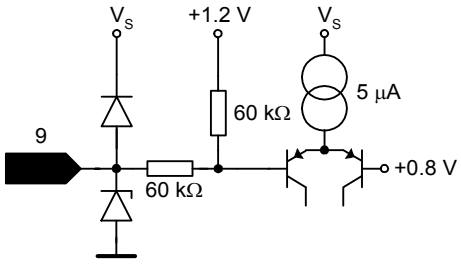
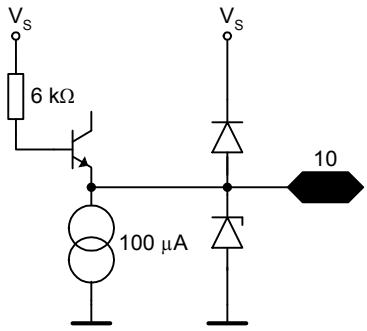
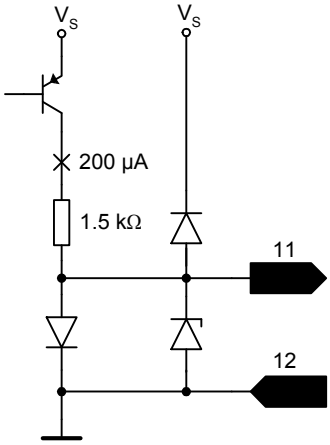
Pin No.	Symbol	Function
1	PDWN	Power Down Mode Control
2	LPD	Low Power Detect Output
3	VS	Voltage Supply
4	LF	Loop Filter
5	GND	Ground
6	ASKDTA	Amplitude Shift Keying Data Input
7	FSKDTA	Frequency Shift Keying Data Input
8	CLKOUT	Clock Driver Output
9	CLKDIV	Clock Divider Control (847.5 kHz or 3.34 MHz)
10	COSC	Crystal Oscillator Input
11	FSKOUT	Frequency Shift Keying Switch Output
12	FSKGND	Frequency Shift Keying Ground
13	PAGND	Power Amplifier Ground
14	PAOUT	Power Amplifier Output
15	FSEL	Frequency Range Selection (433 or 868 MHz)
16	CSEL	Crystal Frequency Selection (6.78 or 13.56 MHz)

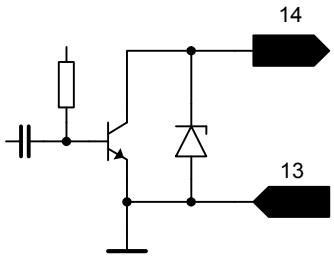
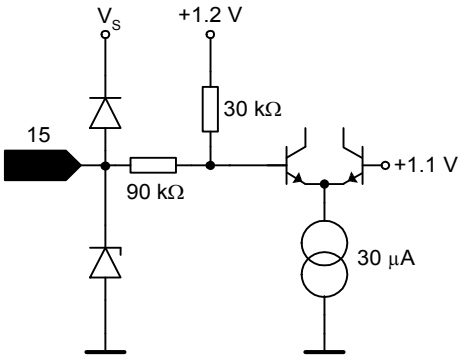
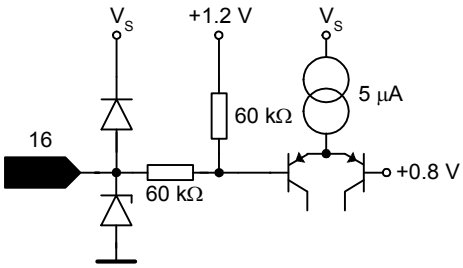
2.2 Pin Definitions and Functions

Table 2-2

Pin No.	Symbol	Interface Schematic*)	Function
1	PDWN		Disable pin for the complete transmitter circuit. A logic low (PDWN < 0.7 V) turns off all transmitter functions. A logic high (PDWN > 1.5 V) gives access to all transmitter functions. PDWN input will be pulled up by 40 µA internally by either setting FSKDTA or ASKDTA to a logic high-state.
2	LPD		This pin provides an output indicating the low-voltage state of the supply voltage VS. VS < 2.15 V will set LPD to the low-state. An internal pull-up current of 40 µA gives the output a high-state at supply voltages above 2.15 V.
3	VS		This pin is the positive supply of the transmitter electronics. An RF bypass capacitor should be connected directly to this pin and returned to GND (pin 5) as short as possible.

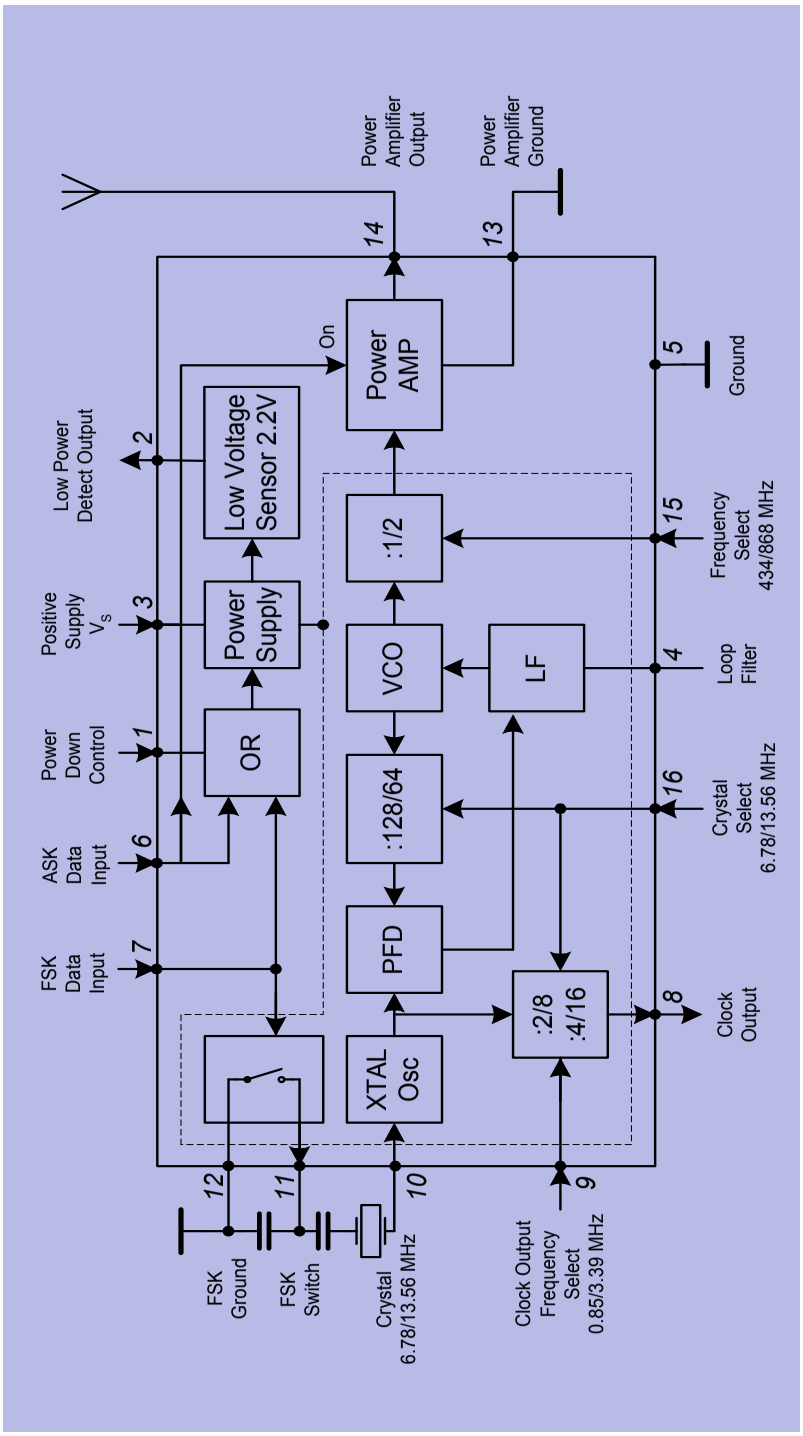
4	LF		Output of the charge pump and input of the VCO control voltage. The loop bandwidth of the PLL is 150 kHz when only the internal loop filter is used. The loop bandwidth may be reduced by applying an external RC network referencing to the positive supply VS (pin 3).
5	GND		General ground connection.
6	ASKDTA		Digital amplitude modulation can be imparted to the Power Amplifier through this pin. A logic high (ASKDTA > 1.5 V or open) enables the Power Amplifier. A logic low (ASKDTA < 0.5 V) disables the Power Amplifier.
7	FSKDTA		Digital frequency modulation can be imparted to the Xtal Oscillator by this pin. The VCO-frequency varies in accordance to the frequency of the reference oscillator. A logic high (FSKDTA > 1.5V or open) sets the FSK switch to a high impedance state. A logic low (FSKDTA < 0.5 V) closes the FSK switch from FSKOUT (pin 11) to FSKGND (pin 12). A capacitor can be switched to the reference crystal network this way. The Xtal Oscillator frequency will be shifted giving the designed FSK frequency deviation.

8	CLKOUT		Clock output to supply an external device. An external pull-up resistor has to be added in accordance to the driving requirements of the external device. A clock frequency of 3.39 MHz is selected by a logic low at CLKDIV input (pin9). A clock frequency of 847.5 kHz is selected by a logic high at CLKDIV input (pin9).
9	CLKDIV		This pin is used to select the desired clock division rate for the CLKOUT signal. A logic low (CLKDIV < 0.2 V) applied to this pin selects the 3.39 MHz output signal at CLKOUT (pin 8). A logic high (CLKDIV open) applied to this pin selects the 847.5 kHz output signal at CLKOUT (pin 8).
10	COSC		This pin is connected to the reference oscillator circuit. The reference oscillator is working as a negative impedance converter. It presents a negative resistance in series to an inductance at the COSC pin.
11	FSKOUT		This pin is connected to a switch to FSKGND (pin 12). The switch is closed when the signal at FSKDTA (pin 7) is in a logic low state. The switch is open when the signal at FSKDTA (pin 7) is in a logic high state. FSKOUT can switch an additional capacitor to the reference crystal network to pull the crystal frequency by an amount resulting in the desired FSK frequency shift of the transmitter output frequency.
12	FSKGND		Ground connection for FSK modulation output FSKOUT.

13	PAGND		Ground connection of the power amplifier. The RF ground return path of the power amplifier output PAOUT (pin 14) has to be concentrated to this pin.
14	PAOUT		RF output pin of the transmitter. A DC path to the positive supply VS has to be supplied by the antenna matching network.
15	FSEL		This pin is used to select the desired transmitter frequency. A logic low (FSEL < 0.5 V) applied to this pin sets the transmitter to the 433 MHz frequency range. A logic high (FSEL open) applied to this pin sets the transmitter to the 868 MHz frequency range.
16	CSEL		This pin is used to select the desired reference frequency. A logic low (CSEL < 0.2 V) applied to this pin sets the internal frequency divider to accept a reference frequency of 6.78 MHz. A logic high (CSEL open) applied to this pin sets the internal frequency divider to accept a reference frequency of 13.56 MHz.

*) Indicated voltages and currents apply for PLL Enable Mode and Transmit Mode.
In Power Down Mode, the values are zero or high-ohmic.

2.3 Functional Block diagram



Block_diagram.wmf

Figure 2-2 Functional Block diagram

2.4 Functional Blocks

2.4.1 PLL Synthesizer

The Phase Locked Loop synthesizer consists of a Voltage Controlled Oscillator (VCO), an asynchronous divider chain, a phase detector, a charge pump and a loop filter. It is fully implemented on chip. The tuning circuit of the VCO consisting of spiral inductors and varactor diodes is on chip, too. Therefore no additional external components are necessary. The nominal center frequency of the VCO is 869 MHz. The oscillator signal is fed both, to the synthesizer divider chain and to the power amplifier. The overall division ratio of the asynchronous divider chain is 128 in case of a 6.78 MHz crystal or 64 in case of a 13.56 MHz crystal and can be selected via CSEL (pin 16). The phase detector is a Type IV PD with charge pump. The passive loop filter is realized on chip.

2.4.2 Crystal Oscillator

The crystal oscillator operates either at 6.78 MHz or at 13.56 MHz.

The reference frequency can be chosen by the signal at CSEL (pin 16).

Table 2-3

CSEL (pin 16)	Crystal Frequency
Low*)	6.78 MHz
Open†)	13.56 MHz

*) Low: Voltage at pin < 0.2 V
†) Open: Pin open

For both quartz frequency options, 847.5 kHz or 3.39 MHz are available as output frequencies of the clock output CLKOUT (pin 8) to drive the clock input of a micro controller.

The frequency at CLKOUT (pin 8) is controlled by the signal at CLKDIV (pin 9)

Table 2-4

CLKDIV (pin 9)	CLKOUT Frequency
Low*)	3.39 MHz
Open†)	847.5 kHz

*) Low: Voltage at pin < 0.2 V
†) Open: Pin open

To achieve FSK transmission, the oscillator frequency can be detuned by a fixed amount by switching an external capacitor via FSKOUT (pin 11).

The condition of the switch is controlled by the signal at FSKDTA (pin 7).

Table 2-5

FSKDTA (pin7)	FSK Switch
Low*)	CLOSED
Open†), High‡)	OPEN

*) Low: Voltage at pin < 0.5 V
†) Open: Pin open
‡) High: Voltage at pin > 1.5 V

2.4.3 Power Amplifier

In case of operation in the 868-870 MHz band, the power amplifier is fed directly from the voltage controlled oscillator. In case of operation in the 433-435 MHz band, the VCO frequency is divided by 2. This is controlled by FSEL (pin 15) as described in the table below.

Table 2-6

FSEL (pin 15)	Radiated Frequency Band
Low*)	433 MHz
Open†)	868 MHz

*) Low: Voltage at pin < 0.5 V
†) Open: Pin open

The Power Amplifier can be switched on and off by the signal at ASKDTA (pin 6).

Table 2-7

ASKDTA (pin 6)	Power Amplifier
Low*)	OFF
Open†), High‡)	ON

*) Low: Voltage at pin < 0.5 V
†) Open: Pin open
‡) High: Voltage at pin > 1.5 V

The Power Amplifier has an Open Collector output at PAOUT (pin 14) and requires an external pull-up coil to provide bias. The coil is part of the tuning and matching LC circuitry to get best performance with the external loop antenna. To achieve the best power amplifier efficiency, the high frequency voltage swing at PAOUT (pin 14) should be twice the supply voltage.

The power amplifier has its own ground pin PAGND (pin 13) in order to reduce the amount of coupling to the other circuits.

2.4.4 Low Power Detect

The supply voltage is sensed by a low power detector. When the supply voltage drops below 2.15 V, the output LPD (pin 2) switches to the low-state. To minimize the external component count, an internal pull-up current of 40 µA gives the output a high-state at supply voltages above 2.15 V.

The output LPD (pin 2) can either be connected to ASKDTA (pin 6) to switch off the PA as soon as the supply voltage drops below 2.15 V or it can be used to inform a micro-controller to stop the transmission after the current data packet.

2.4.5 Power Modes

The IC provides three power modes, the POWER DOWN MODE, the PLL ENABLE MODE and the TRANSMIT MODE.

2.4.5.1 Power Down Mode

In the POWER DOWN MODE the complete chip is switched off.

The current consumption is typically 0.3 nA at 3 V 25°C.

This current doubles every 8°C. The values for higher temperatures are typically 14 nA at 85°C and typically 600 nA at 125°C.

2.4.5.2 PLL Enable Mode

In the PLL ENABLE MODE the PLL is switched on but the power amplifier is turned off to avoid undesired power radiation during the time the PLL needs to settle. The turn on time of the PLL is determined mainly by the turn on time of the crystal oscillator and is less than 1 msec when the specified crystal is used.

The current consumption is typically 3.5 mA.

2.4.5.3 Transmit Mode

In the TRANSMIT MODE the PLL is switched on and the power amplifier is turned on too.

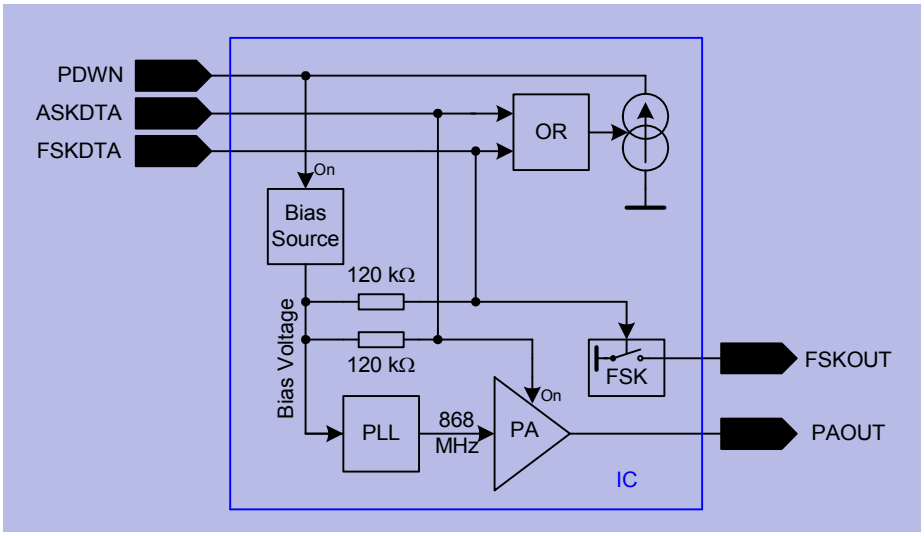
The current consumption of the IC is typically 7 mA when using a proper transforming network at PAOUT, see Figure 3-1.

2.4.5.4 Power mode control

The bias circuitry is powered up via a voltage V > 1.5 V at the pin PDWN (pin 1). When the bias circuitry is powered up, the pins ASKDTA and FSKDTA are pulled up internally.
Forcing the voltage at the pins low overrides the internally set state.

Alternatively, if the voltage at ASKDTA or FSKDTA is forced high externally, the PDWN pin is pulled up internally via a current source. In this case, it is not necessary to connect the PDWN pin, it is recommended to leave it open.

The principle schematic of the power mode control circuitry is shown in Figure 3-5.



Power_Mode.wmf

Figure 2-5 Power mode control circuitry

Table 3-8 provides a listing of how to get into the different power modes

Table 2-8

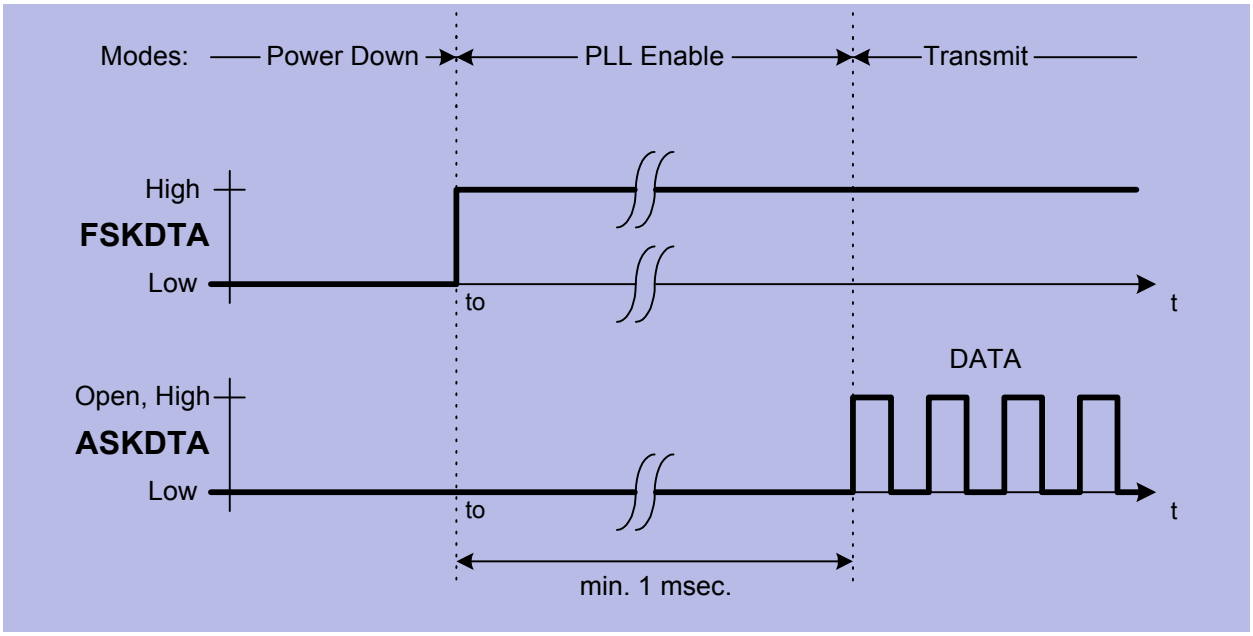
PDWN	FSKDTA	ASKDTA	MODE
Low*)	Low, Open	Low, Open	POWER DOWN
Open†)	Low	Low	
High‡)	Low, Open, High	Low	PLL ENABLE
Open	High	Low	
High	Low, Open, High	Open, High	TRANSMIT
Open	High	Open, High	
Open	Low, Open, High	High	

*) Low: Voltage at pin < 0.7 V (PDWN)
Voltage at pin < 0.5 V (FSKDTA, ASKDTA)
†) Open: Pin open
‡) High: Voltage at pin > 1.5 V

Other combinations of the control pins PDWN, FSKDTA and ASKDTA are not recommended.

2.4.6 Recommended timing diagrams for ASK- and FSK-Modulation

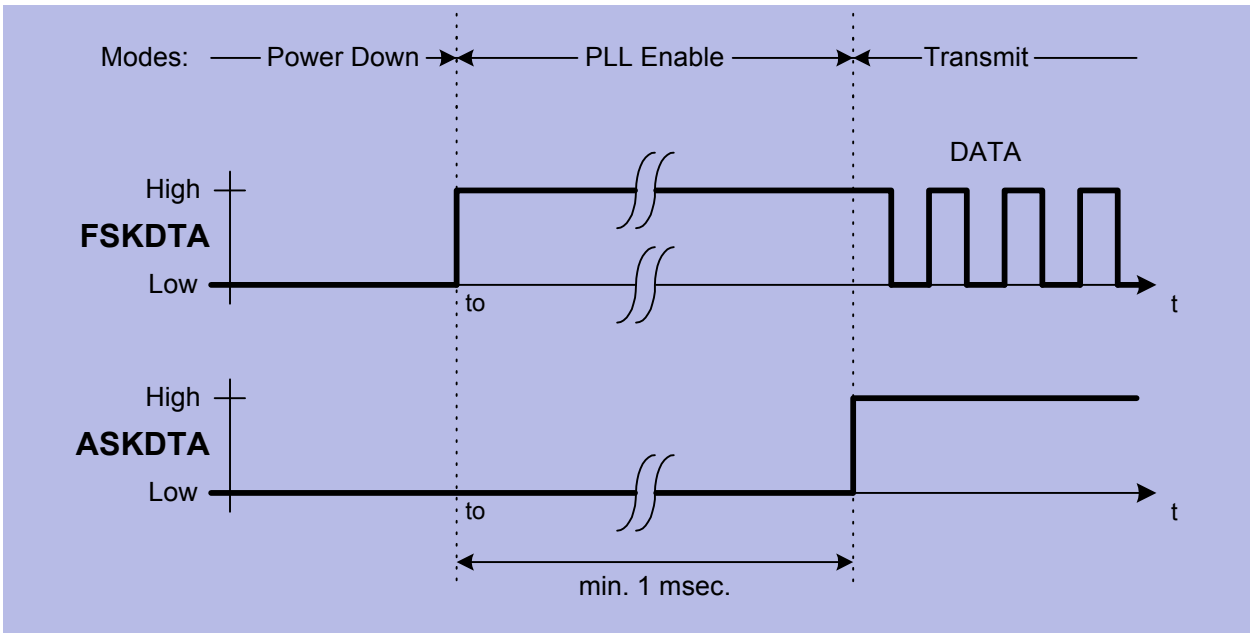
ASK Modulation using FSKDTA and ASKDTA, PDWN not connected



ASK_mod.wmf

Figure 2-6 ASK Modulation

FSK Modulation using FSKDTA and ASKDTA, PDWN not connected



FSK_mod.wmf

Figure 2-7 FSK Modulation

Alternative ASK Modulation, FSKDTA not connected.

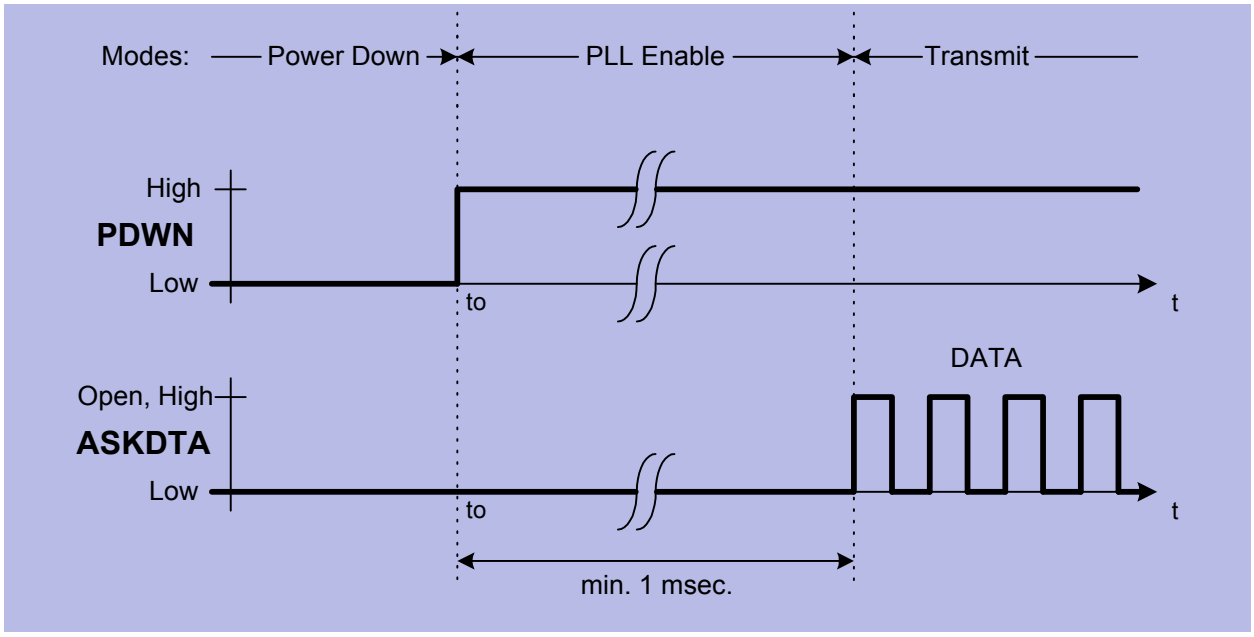


Figure 2-8 Alternative ASK Modulation

Alternative FSK Modulation

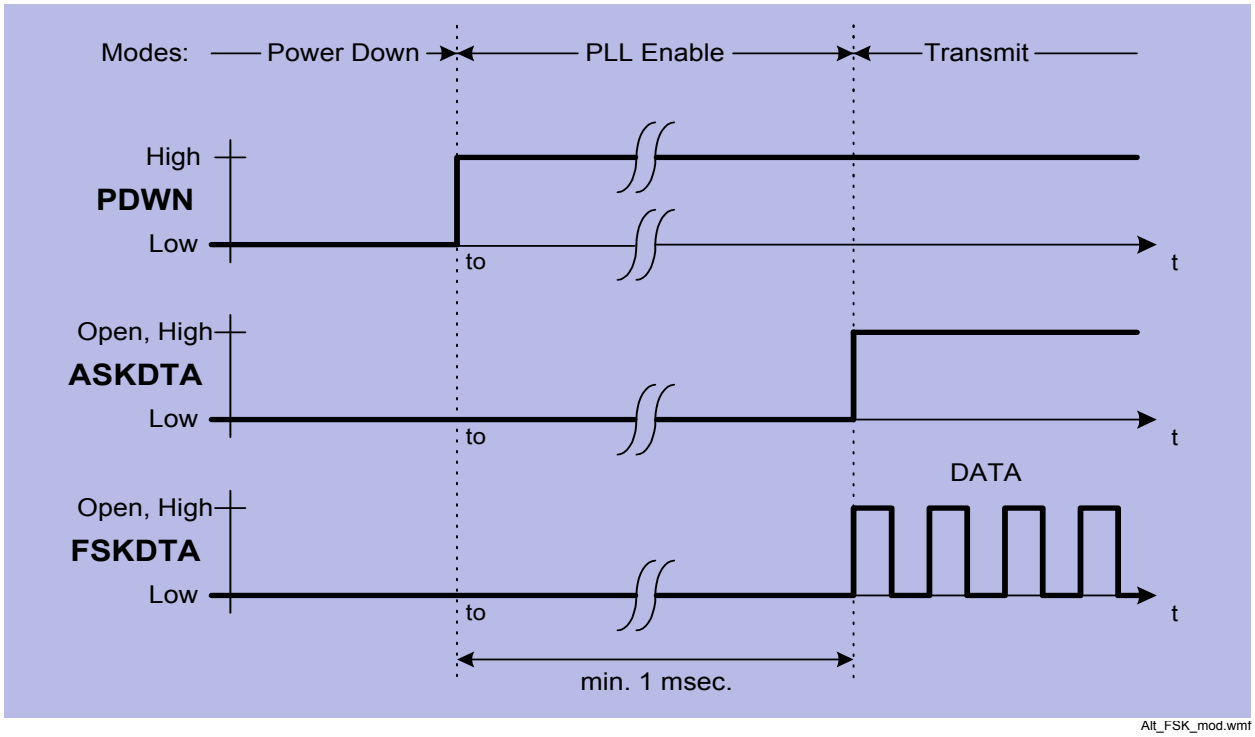
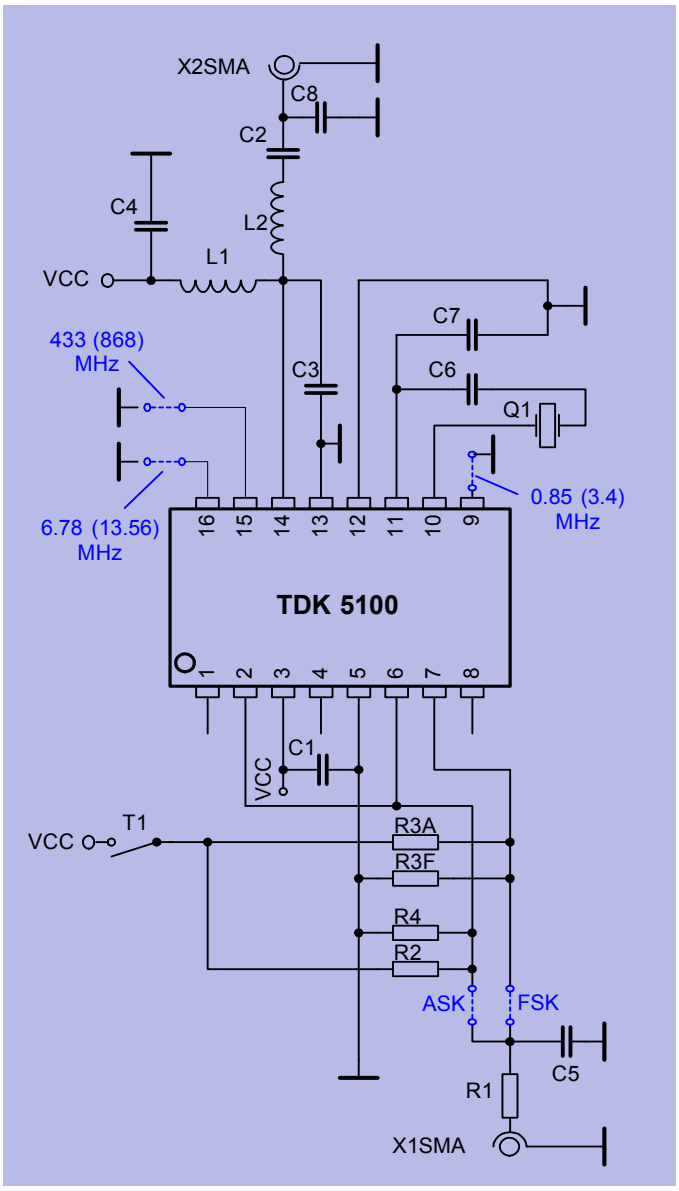


Figure 2-9 Alternative FSK Modulation

3 Applications

Contents of this Chapter

3.1 50 Ohm-Output Testboard Schematic



50ohm_test_v5.wmf

Figure 3-1 50 Ω - output testboard schematic

3.2 50 Ohm-Output Testboard Layout

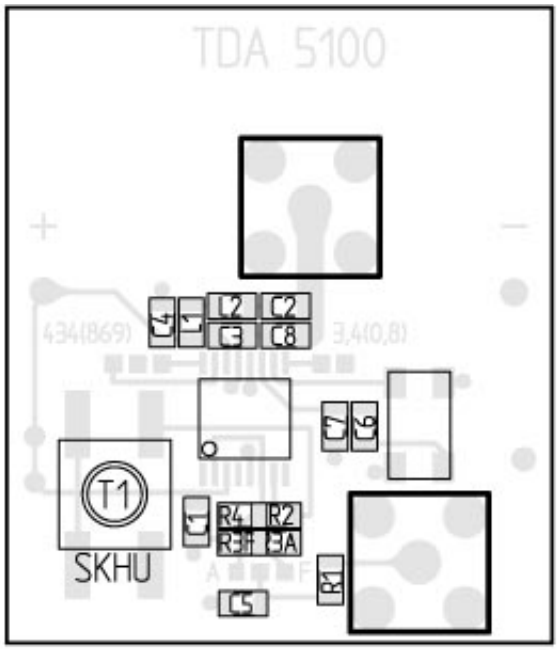


Figure 3-2 Top Side of TDK 5100-Testboard with 50 Ω - Output

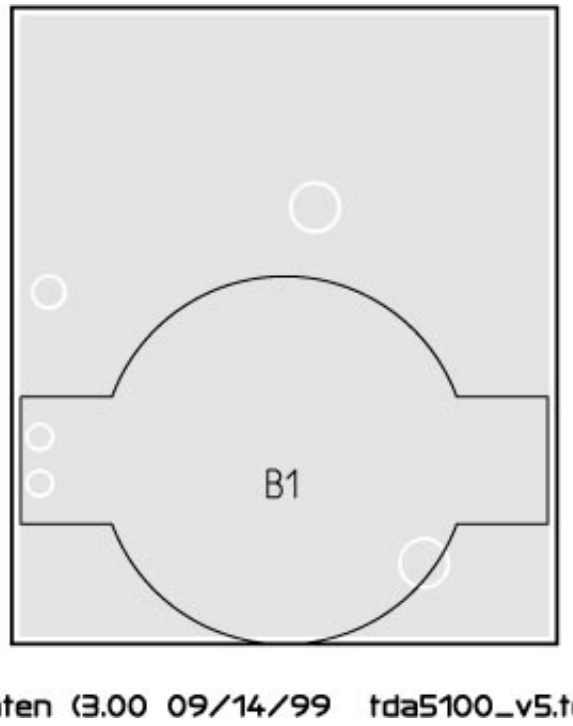


Figure 3-3 Bottom Side of TDK 5100-Testboard with 50 Ω - Output

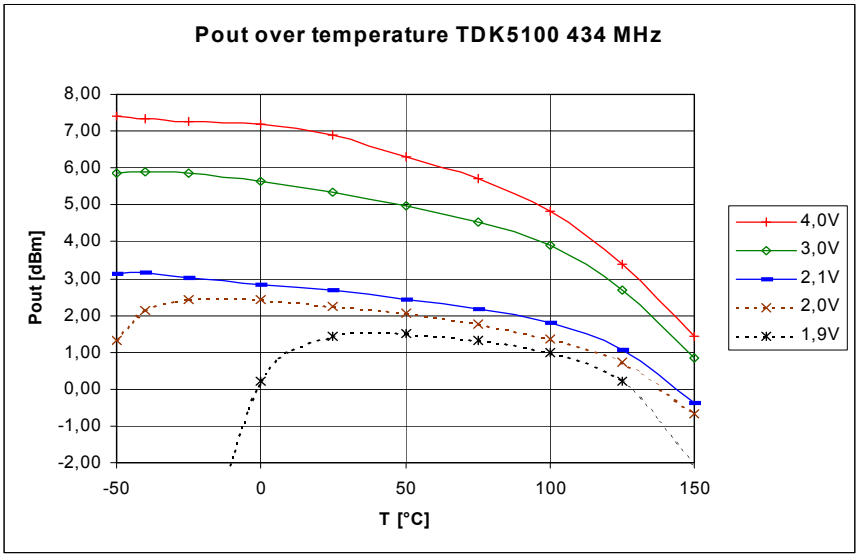
3.3 Bill of material (50 Ohm-Output Testboard)

Table 3-1 Bill of material

Part	Value	434 MHz	869 MHz	ASK	FSK	Specification
R1	4.7 kΩ					0805, ± 5%
R2					12 kΩ	0805, ± 5%
R3A				15 kΩ		0805, ± 5%
R3F					15 kΩ	0805, ± 5%
R4	open					0805, ± 5%
C1	47 nF					0805, X7R, ± 10%
C2		39 pF	47 pF			0805, COG, ± 5%
C3		3.9 pF	1.8 pF			0805, COG, ± 0.1 pF
C4		330 pF	100 pF			0805, COG, ± 5%
C5	1 nF					0805, X7R, ± 10%
C6	8.2 pF					0805, COG, ± 0.1 pF
C7				0Ω Jumper	434MHz: 22 pF 868MHz: 47pF	0805, COG, ± 5% 0805, 0Ω Jumper
C8		15 pF	8.2 pF			0805, COG, ± 5%
L1		100 nH	33 nH			TOKO LL2012-J
L2		39 nH	15 nH			39 nH: TOKO LL2012-J 15 nH: TOKO LL1608-J
Q1	13.56875 MHz, CL=20pF					Tokyo Denpa TSS-3B 13568.75 kHz Spec.No. 10-50205
IC1	TDK5100					
T1	Push-button					replaced by a short
X1	SMA-S					SMA standing
X2	SMA-S					SMA standing

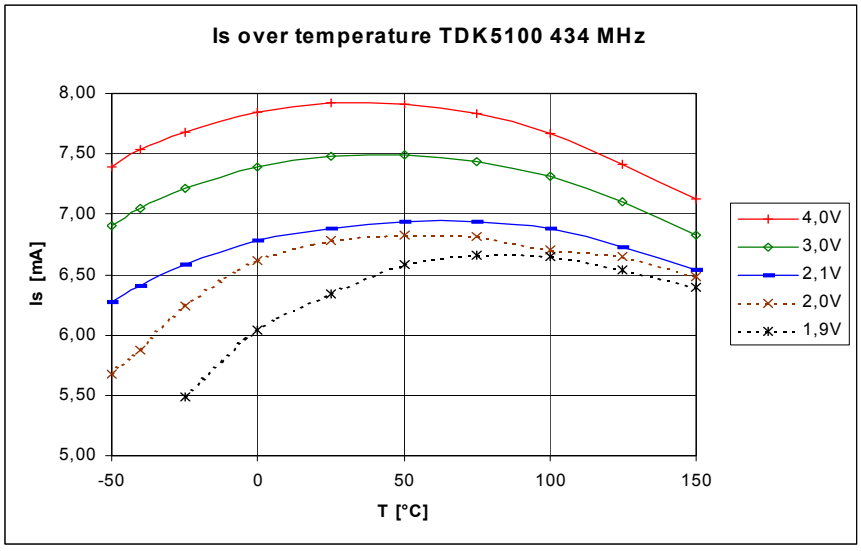
3.4 50 Ohm-Output Testboard: Measurement results

Note the specified operating range: 2.1 V to 4.0 V and -40°C to +125°C.



pout_over_temp_434.wmf

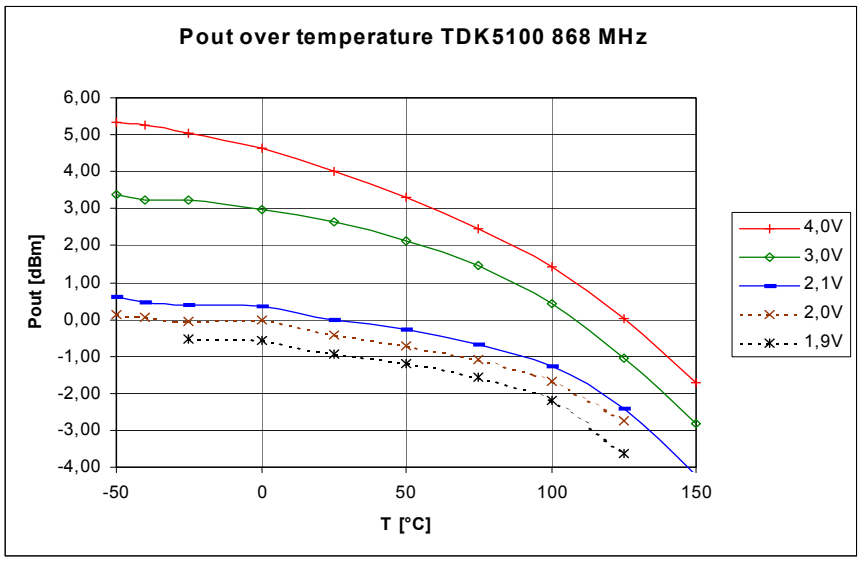
Figure 3-4 Output power over temperature of the 50 Ω - testboard with TDK 5100 at 434 MHz



Is_over_temp_434.wmf

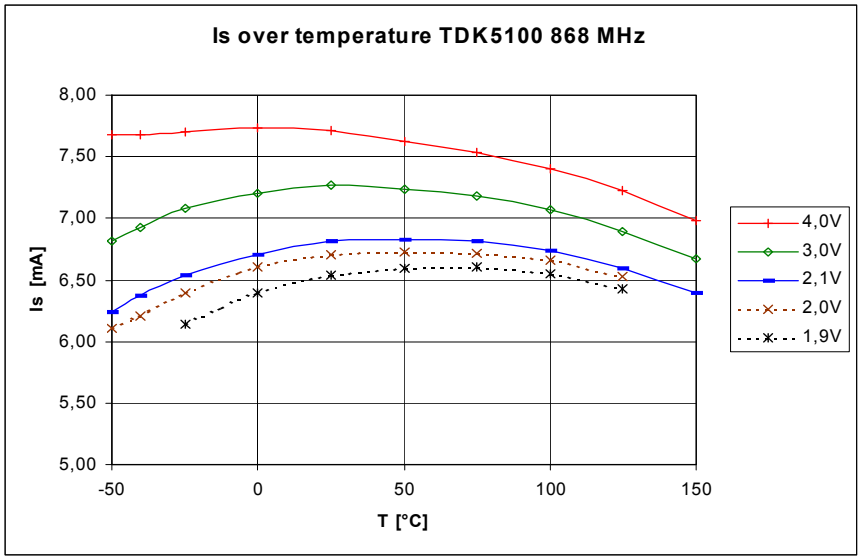
Figure 3-5 Supply current over temperature of the 50 Ω - testboard with TDK 5100 at 434 MHz

Note the specified operating range: 2.1 V to 4.0 V and -40°C to +125°C.



pout_over_temp_868.wmf

Figure 3-6 Output power over temperature of the 50 Ω - testboard with TDK 5100 at 868 MHz



is_over_temp_868.wmf

Figure 3-7 Supply current over temperature of the 50 Ω - testboard with TDK 5100 at 868 MHz